



SANYO Semiconductors

## DATA SHEET

N-Channel Silicon MOSFET

# MCH3479 — General-Purpose Switching Device Applications

## Features

- ON-resistance  $R_{DS(on)} = 49\text{m}\Omega$  (typ.)
- 1.8V drive
- Halogen free compliance
- Protection diode in

## Specifications

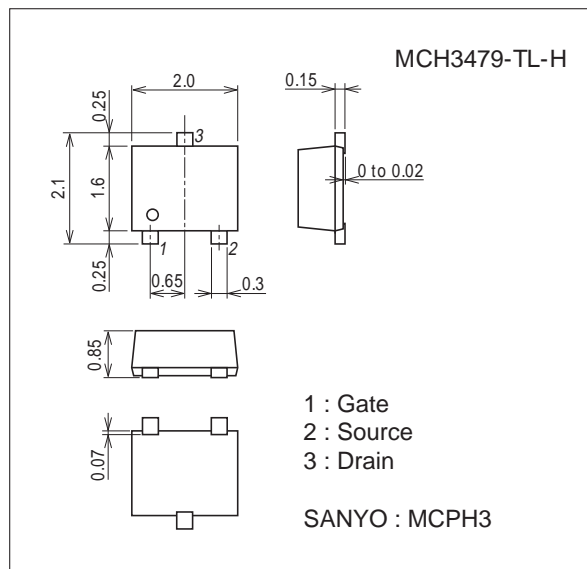
Absolute Maximum Ratings at  $T_a = 25^\circ\text{C}$ 

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	$V_{DS}$		20	V
Gate-to-Source Voltage	$V_{GS}$		$\pm 12$	V
Drain Current (DC)	$I_D$		3.5	A
Drain Current (Pulse)	$I_{DP}$	$PW \leq 10\mu\text{s}$ , duty cycle $\leq 1\%$	14	A
Allowable Power Dissipation	$P_D$	When mounted on ceramic substrate ( $900\text{mm}^2 \times 0.8\text{mm}$ )	0.9	W
Channel Temperature	$T_{ch}$		150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$		-55 to +150	$^\circ\text{C}$

## Package Dimensions

unit : mm (typ)

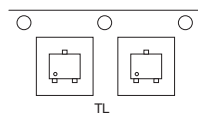
7019A-003



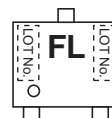
## Product & Package Information

- Package : MCPH3
- JEITA, JEDEC : SC-70, SOT-323
- Minimum Packing Quantity : 3,000 pcs./reel

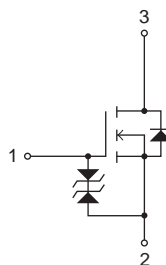
## Packing Type : TL



## Marking



## Electrical Connection

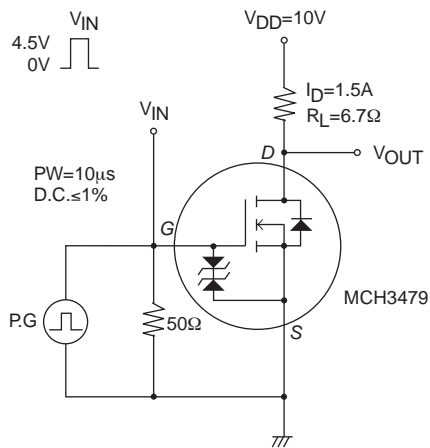


# MCH3479

## Electrical Characteristics at Ta=25°C

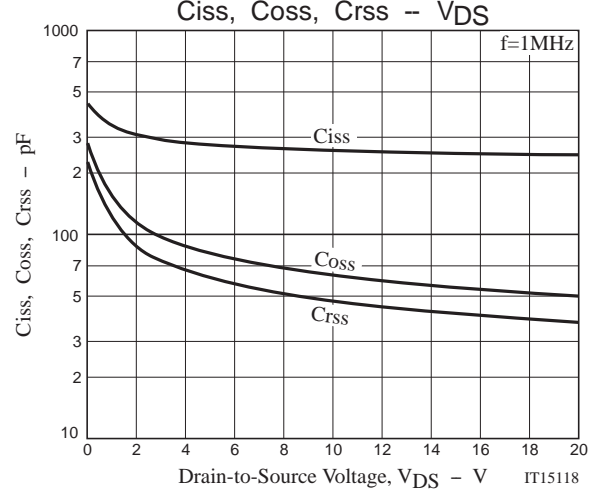
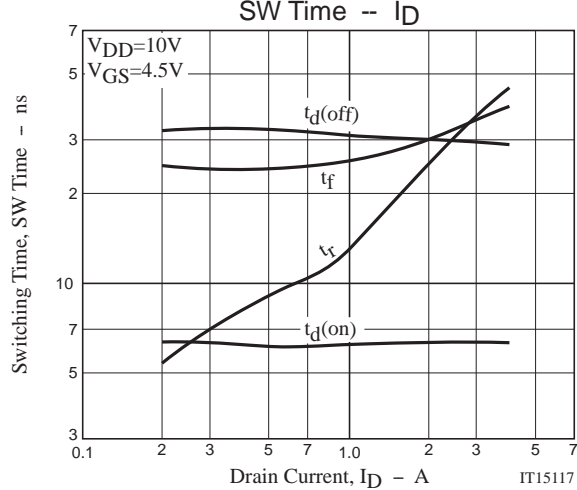
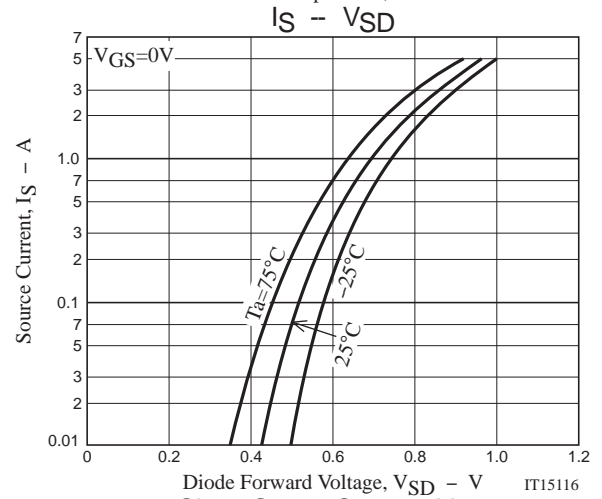
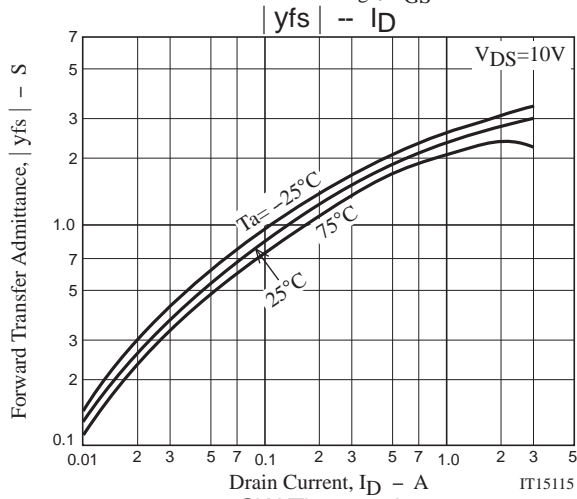
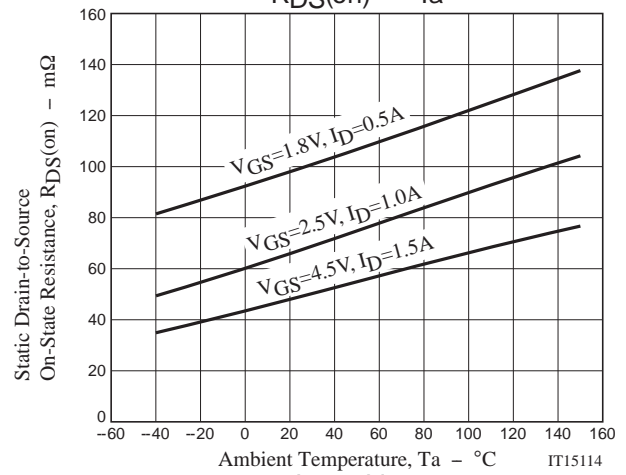
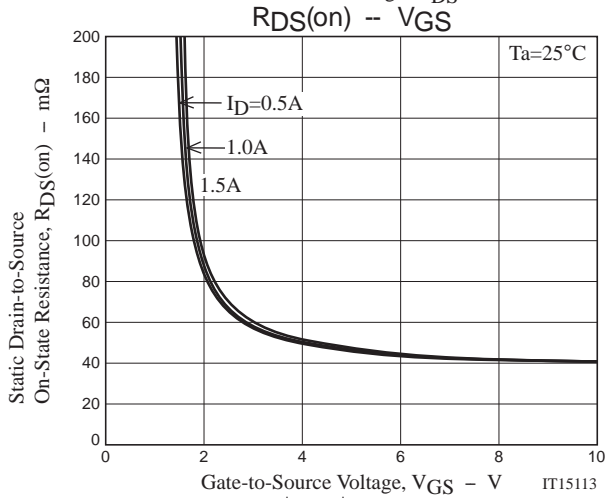
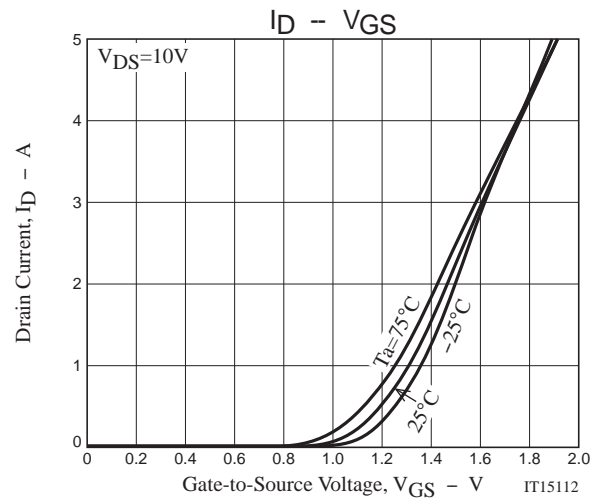
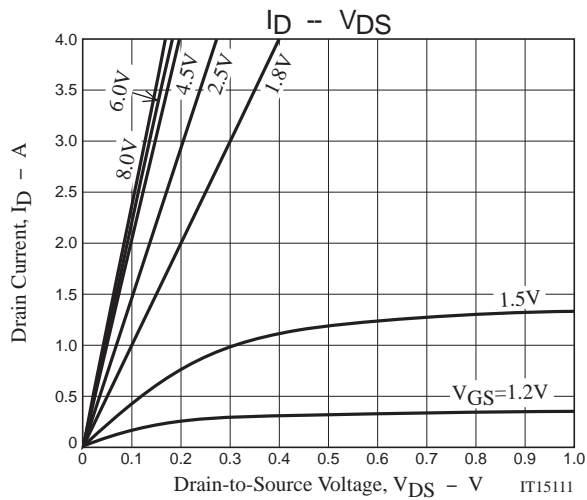
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Drain-to-Source Breakdown Voltage	$V_{(BR)DSS}$	$I_D=1mA, V_{GS}=0V$	20			V
Zero-Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=20V, V_{GS}=0V$			1	$\mu A$
Gate-to-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 8V, V_{DS}=0V$			$\pm 10$	$\mu A$
Cutoff Voltage	$V_{GS(off)}$	$V_{DS}=10V, I_D=1mA$	0.4		1.3	V
Forward Transfer Admittance	$ y_{fs} $	$V_{DS}=10V, I_D=1.5A$		2.8		S
Static Drain-to-Source On-State Resistance	$R_{DS(on)1}$	$I_D=1.5A, V_{GS}=4.5V$		49	64	m $\Omega$
	$R_{DS(on)2}$	$I_D=1A, V_{GS}=2.5V$		68	95	m $\Omega$
	$R_{DS(on)3}$	$I_D=0.5A, V_{GS}=1.8V$		99	149	m $\Omega$
Input Capacitance	$C_{iss}$	$V_{DS}=10V, f=1MHz$		260		pF
Output Capacitance	$C_{oss}$			65		pF
Reverse Transfer Capacitance	$C_{rss}$			50		pF
Turn-ON Delay Time	$t_d(on)$			6.2		ns
Rise Time	$t_r$	See specified Test Circuit.		19		ns
Turn-OFF Delay Time	$t_d(off)$			30		ns
Fall Time	$t_f$			28		ns
Total Gate Charge	$Q_g$	$V_{DS}=10V, V_{GS}=4.5V, I_D=3.5A$		2.8		nC
Gate-to-Source Charge	$Q_{gs}$			0.6		nC
Gate-to-Drain "Miller" Charge	$Q_{gd}$			0.9		nC
Diode Forward Voltage	$V_{SD}$	$I_S=3.5A, V_{GS}=0V$		0.85	1.2	V

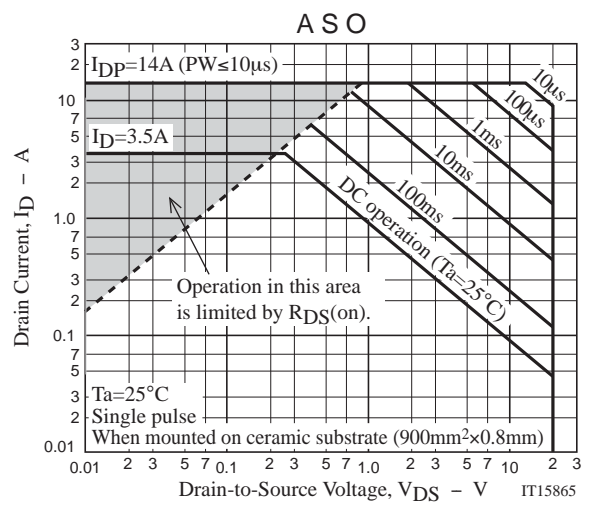
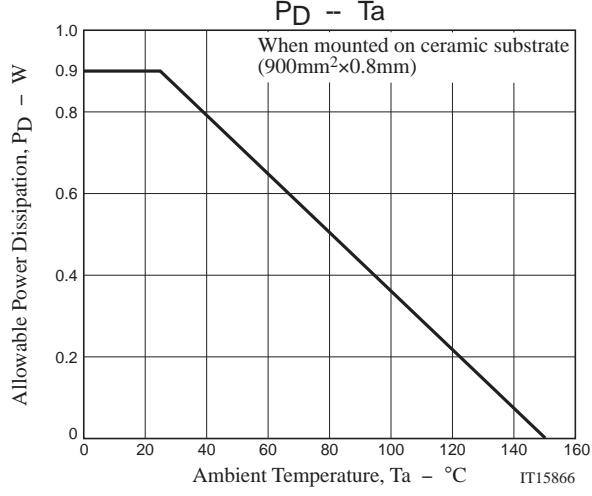
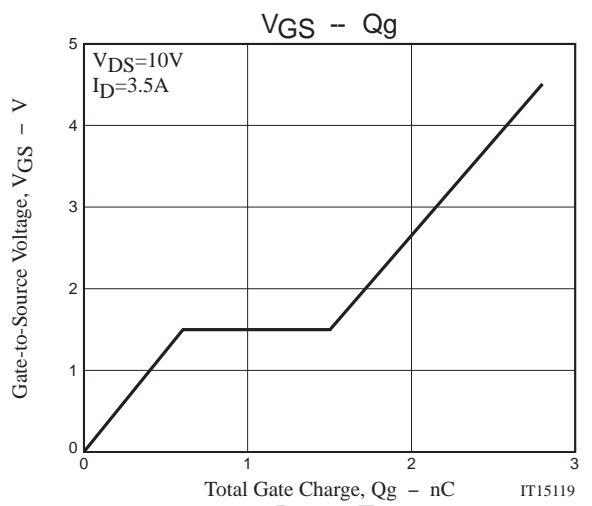
## Switching Time Test Circuit



## Ordering Information

Device	Package	Shipping	memo
MCH3479-TL-H	MCPH3	3,000pcs./reel	Pb Free and Halogen Free





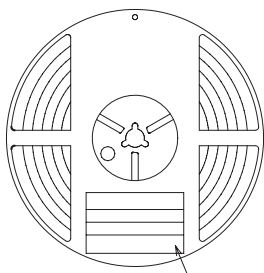
## Taping Specification

MCH3479-TL-H

## 1. Packing Format

Package Name	Carrier Tape Type	Maximum Number of devices contained (pcs)			Packing format	
		Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
MCPH3	MCPH3	3,000	15,000	90,000	5 reels contained Dimensions:mm (external) 183×72×185	6 inner boxes contained Dimensions:mm (external) 440×195×210

## Packing method



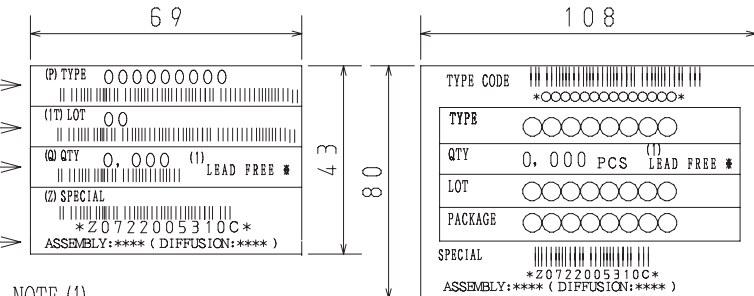
Reel label

Type No.  
LOT No.  
Quantity  
Origin

Reel label, Inner box label  
(unit:mm)

Outer box label

It is a label at the time of factory shipments.  
The form of a label may change in physical  
distribution process.



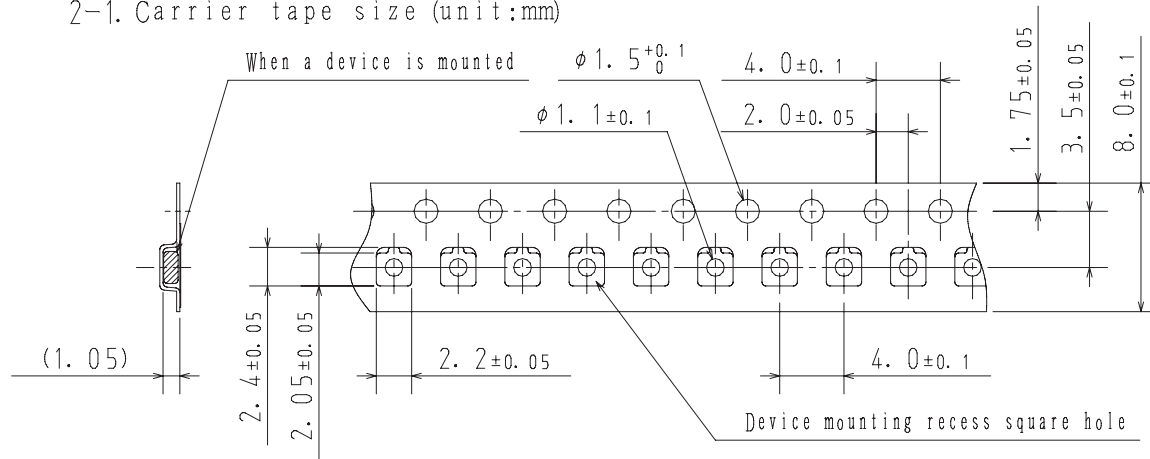
NOTE (1)

The LEAD FREE \* description shows that the surface  
treatment of the terminal is lead free.

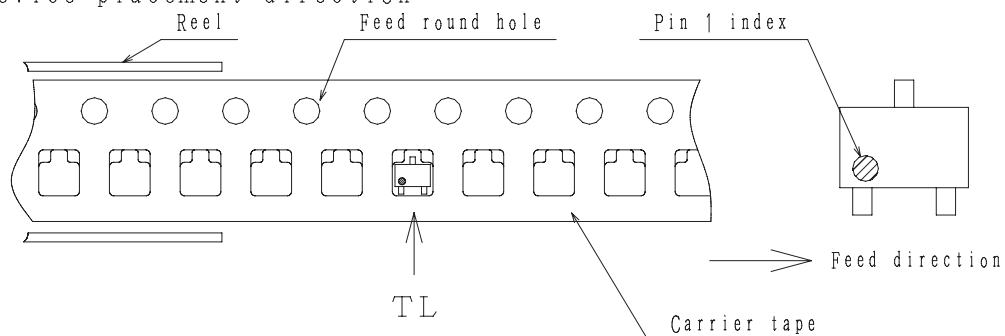
Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3

## 2. Taping configuration

## 2-1. Carrier tape size (unit:mm)

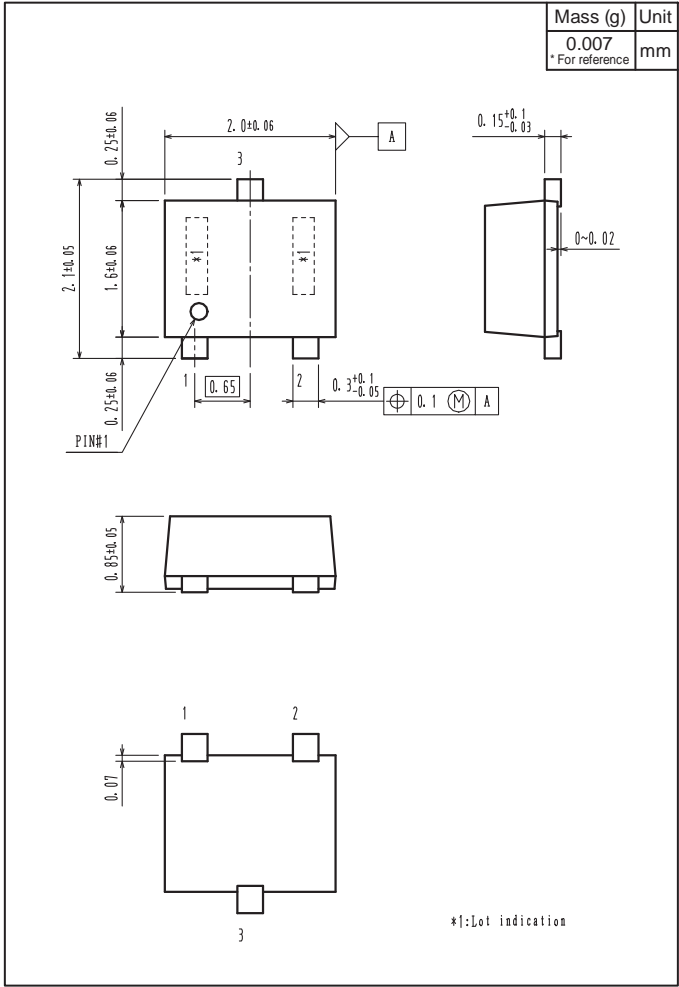


## 2-2. Device placement direction

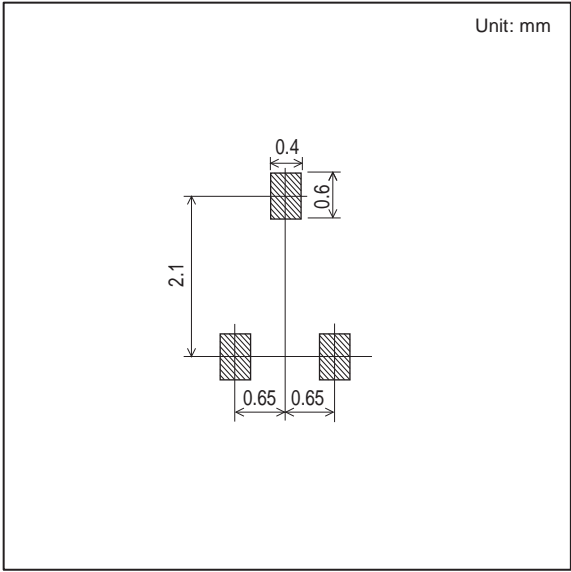


Those with pin 1 index on the feed hole side.....TL

Outline Drawing  
MCH3479-TL-H



Land Pattern Example



Note on usage : Since the MCH3479 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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